

**AMENDMENTS TO THE SPECIFICATION**

Please replace paragraph 0006 with the following new paragraph:

[0006] Furthermore, FIG. 9 shows a situation in which shield case 107 is attached by way of adhesive 106 to the top face 101a of substrate 101 of the infrared communication device constituted as described above. Note, however, that FIG. 9 is drawn such that it is possible to see through shield case 107 attached thereto and view the features therebelow.